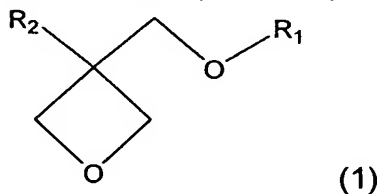


ABSTRACT

The present invention relates to a radiation curable resin composition that can be used when producing an electronic component or an optical component and that can also be used in printing, etc. The present invention also relates to a cured material formed by curing the radiation curable composition by irradiation with actinic radiation. The radiation curable resin composition of the present invention is a radiation curable resin composition that includes a polyfunctional epoxy polymer (Component A) having a polybutadiene skeleton or a hydrogenated polybutadiene skeleton and two or more glycidyloxy groups in the molecule; an oxetane compound (Component B) represented by Formula (1) below and/or a monofunctional epoxy compound (Component C) having 8 to 30 carbons; and a cationic photopolymerization initiator (Component X).



In Formula (1), R₁ denotes an optionally branched alkyl group having 6 to 30 carbons, or a phenyl group substituted with an alkyl group having 4 to 30 carbons, and R₂ denotes a hydrogen atom or an optionally branched alkyl group having 1 to 6 carbons.